

CHAMP and SWARM Modelling

SPINE Meeting
13-14 November 2008
ESTEC

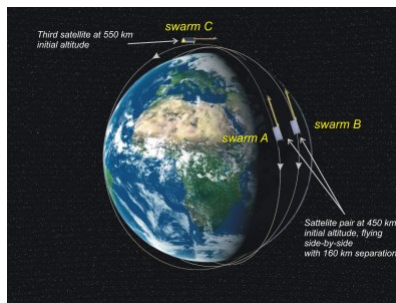
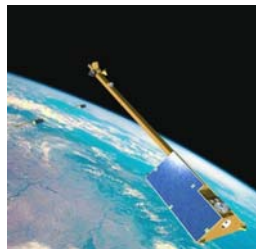
David Rodgers / ESTEC
Simon Clucas / ESTEC
Julien Forest / Artnum
Jean-Francois Roussel / ONERA



Electromagnetics & Space
Environment Division – TEC-EES

SWARM

- 3-satellite mission
- Polar orbits
- 400 to 550km altitude
- Goal: Precise high-resolution B-field measurements



- CHAMP-like satellites
- Ram-facing
conductive plate?



Electromagnetics & Space
Environment Division – TEC-EES

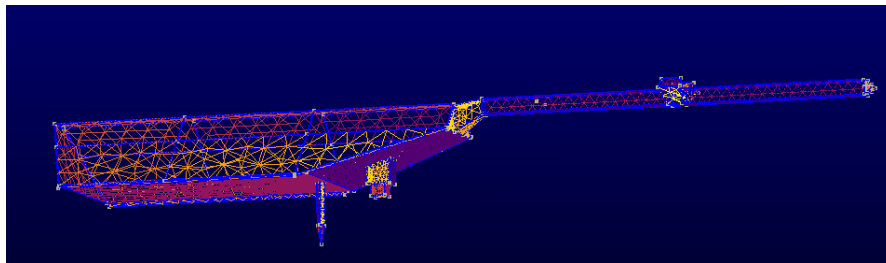
SWARM analysis

- The goals of this study were to assess:
 - the floating potential of the spacecraft
 - the electric fields in the vicinity of the electric field instrument.
 - the changes that would be expected if there were no conductive plate, or if the plate were smaller
 - the effect of using a paint that was not as conductive as a metal



Electromagnetics & Space
Environment Division – TEC-EES

Modelling CHAMP



Gmsh model input to SPIS

Surface Properties

CERS
Teflon
Aluminium Oxide
Kapton
BLKC

Global parameters

Ions=PIC
Electrons=Global Maxwell Boltzmann
Vel=7710 m/s
IonType = O+



Electromagnetics & Space
Environment Division – TEC-EES

CHAMP inputs

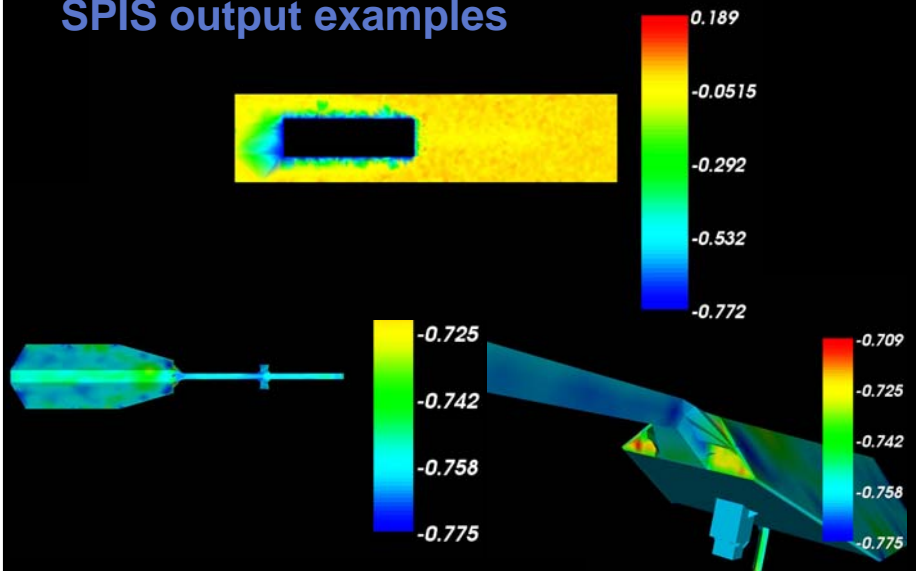
- Three charging regimes were chosen from the environment data experienced by CHAMP
- Ion temperature was not available. IRI2001 indicates that this is nearly constant around 770K

Case	Te (K)	Ti (K)	ni=ne density (/m3)	Sun/ Eclipse	Sun direction	Phi (V)
A	994	770	2.74×10^{11}	Sunlit	+y	-1.106
B	1984	770	8.64×10^{11}	Sunlit	+y	-1.002
C	1719	770	4.46×10^{11}	Sunlit	+y	-0.863



Electromagnetics & Space
Environment Division – TEC-EES

SPIS output examples



Electromagnetics & Space
Environment Division – TEC-EES

CHAMP results

- In cases A, B and C, floating potential was the same in eclipse as in sunlight
 - i.e. floating potential was dominated by ion ram and thermal electron collection – photo-emission was of minor importance.
 - all floating potentials were negative

Case	Te (K)	Ti (K)	Ion density (ions/m ³)	Obs. (V)	SPIS (V)
A	994	770	2.74x10 ¹¹	-1.106	-0.340
B	1984	770	8.64x10 ¹¹	-1.002	-0.685
C	1719	770	4.46x10 ¹¹	-0.863	-0.612

- SPIS simulated potentials less negative than observations
- However, V_{sat} does not have the expected relation to T_e



Electromagnetics & Space
Environment Division – TEC-EES

SWARM Environment

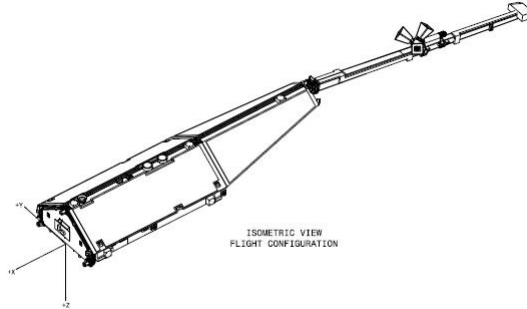
Case	Plasma density (cm ⁻³)	Electron Temp. (eV)	Ion Temp. (eV)	Debye length (mm)
A	1.24x10 ⁶	0.116	0.083	2.27
B	1.75x10 ⁵	0.232	0.131	8.53
C	5.72x10 ⁵	0.125	0.109	3.46
D	8.88x10 ⁴	0.237	0.144	12.1

- High and low densities were chosen for max and min altitude from IRI
- Velocity = 7700km/s
- Ions = O⁺



Electromagnetics & Space
Environment Division – TEC-EES

SWARM



- Ram plate (0 to 0.35m²)
- Solar array
 - 64 strings of 24 cells. V_{\max} -60V, 0.075m² exposed conductor
 - There are 7860 interconnects and 128 string ends



Electromagnetics & Space
Environment Division – TEC-EES

Modelling SWARM potential

- We cannot simulate the individual interconnects
- 2mm characteristic size compares with λ_D from 2 to 12mm
- Amalgamating the interconnects may change the nature of the current collection
- Three approaches
 - Bound problem with thin and thick sheath approximations
 - Model interconnector to find I(V)
 - Model 3-d spacecraft



Electromagnetics & Space
Environment Division – TEC-EES

Thin/Thick sheath approach

- Thin and thick sheath approximations for attracted species
- Boltzmann for repelled species
- Ion collection to ram given by spacecraft velocity

Plate size m ²	Environment	Photoemission	Potential (V) (thin sheath)	Potential (V) (thick sheath)
0.35	A	Yes	-0.238	-0.082
0	A	Yes	-0.412	+0.592

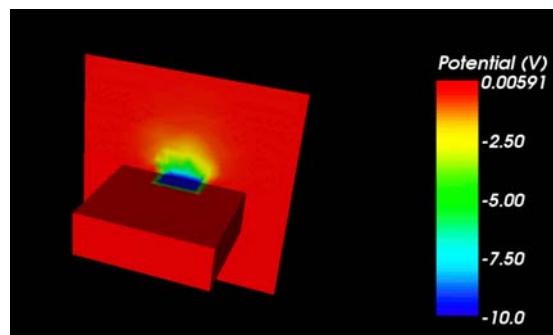
- Potentials between +0.6 and -1.0V



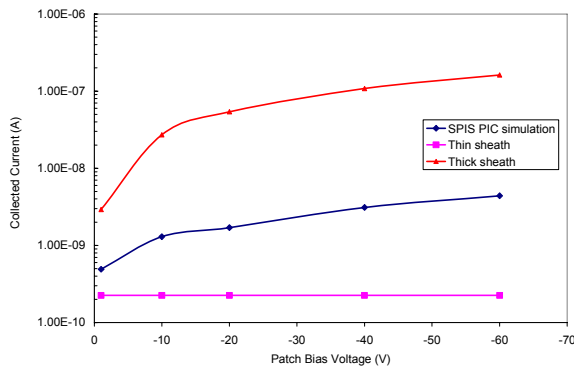
Electromagnetics & Space
Environment Division – TEC-EES

Interconnector modelling approach

- I-V curve simulated with PIC simulation



Electromagnetics & Space
Environment Division – TEC-EES



- Case A
- I(V) resembles thick sheath case divided by 10.
- I(V) closer to thin sheath than thick sheath

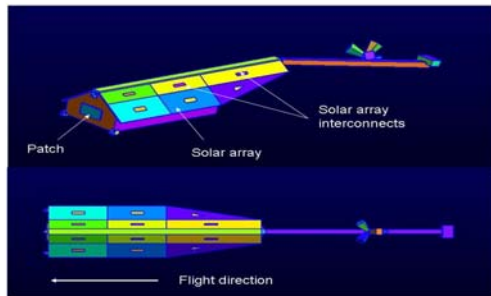
Plate size m ²	Environment	Photoemission	Potential (V) (thick sheath adjusted by factor 10)
0.35	A	Yes	-0.209
0	A	Yes	-0.051

- Potentials between -0.5 and -0.05V



Electromagnetics & Space
Environment Division – TEC-EES

3-D SPIS Modelling

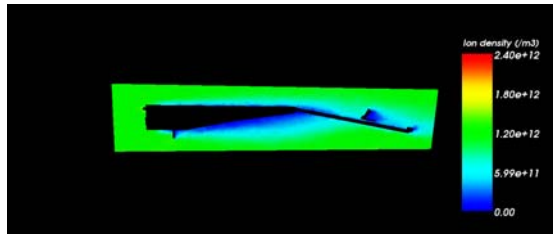


Case	Plate m ²	Photo-emission	Potential (V) Theoretical Thin sheath full	Potential (V) (thick sheath adjusted by factor 10)	Potential (V) SPIS
A	0.35	Yes	-0.238	-0.209	-0.23
A	0	Yes	-0.412	-0.051	-0.065

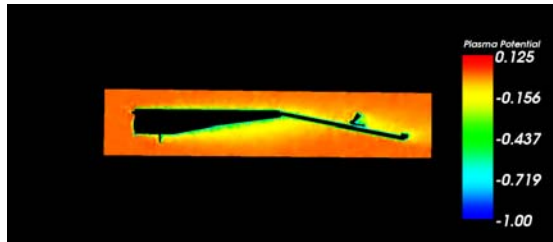
Potentials between -0.2 and -0.6V



Electromagnetics & Space
Environment Division – TEC-EES



Case D

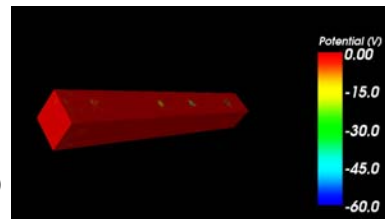


Electromagnetics & Space
Environment Division – TEC-EES

Ram plate calculation

environment	photoemission	Plate m2
A	Yes	0.14
B	Yes	0.065
C	Yes	0.11
D	Yes	0.06

Equating electron and ion current (thick sheath)



Environment	photoemission	Plate m2	Potential (V)
A	Yes	0.35	-0.25
A	Yes	0.125	-0.24
A	Yes	0.05	-0.25
A	Yes	0.01	-0.4
A	Yes	0	-0.42

Environment	photoemission	Plate m2	Resistance Ohms/square	Potential
A	Yes	0.125	200	-0.25
A	Yes	0.125	800	-0.25
A	Yes	0.125	2.0E3	-0.27
A	Yes	0.125	2.0E4	-0.42



Electromagnetics & Space
Environment Division – TEC-EES

Conclusions

- With a ram plate of sufficient size, the spacecraft will remain negative in the region of -0.2 to -0.6V
- With no ram plate, the floating potential will lie within the thin and thick sheath approximations, +0.6 to -1V
 - Potential will likely be -0.05 to -0.5V.
 - No high positive potentials because 1/3 of the array conductive surface is at spacecraft ground.
 - However, small design changes may affect this result
- SPIS simulations show that even for the longest Debye length case (D), it is possible to get away from the influence of the spacecraft with a probe boom of a few cm.
- To be certain of remaining in the “ram dominated” situation you need
 - a plate size of around 0.14m²
 - a plate resistance of less than 1.7x10³ Ohms/square



Electromagnetics & Space
Environment Division – TEC-EES

THE END



Electromagnetics & Space
Environment Division – TEC-EES